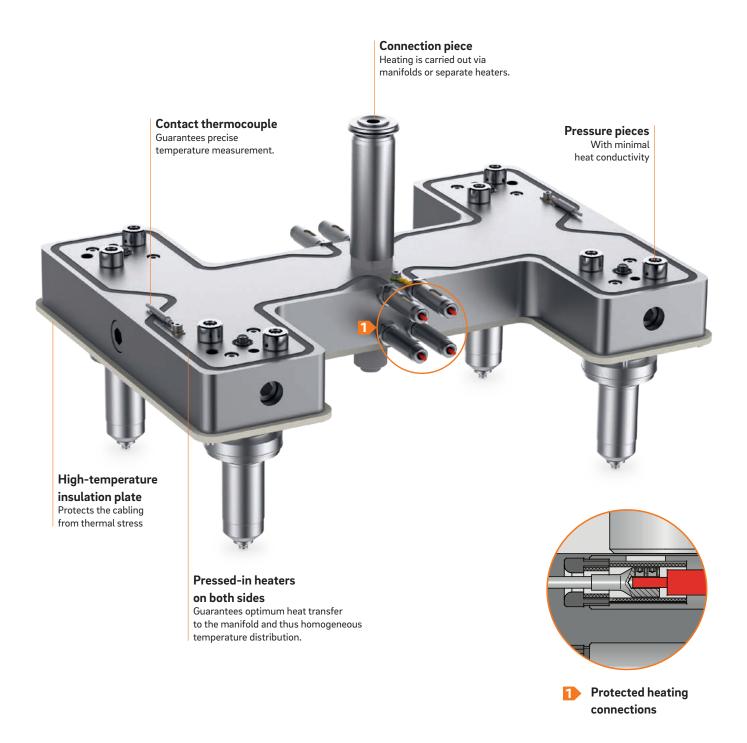




Manifold systems

Different manifold versions can be selected for different applications, from partially or fully balanced to customer-specific special solutions. Flexible positioning of hot runner nozzles with a manifold make individualised mould design possible.



HOMOGENEOUS TEMPERATURE MANAGEMENT THANKS TO PRESSED-IN HEATERS

All melt-conducting components are heated externally, which ensures optimum plastic flow with the smallest possible pressure loss. Pressed-in heaters on both sides guarantee optimum heat transfer to the manifold block. This results in homogeneous temperature distribution.

PROTECTED POWER CONNECTIONS – HIGHLY MAINTENANCE FRIENDLY

Steel and ceramic sleeves protect the power connections from damage. Mechanical cleaning of the manifold channels is easy and fast. Cleaning in the fluid bed bath and oven is also possible. The model data in the CADHOC® System Designer library can be configured (and are thus quickly available) for both individual and standard manifolds.

THE ADVANTAGES AT A GLANCE

- Homogeneous temperature distribution
- Variable nozzle positions
- Power connections with external damage protection
- Easy and fast cleaning
- Model data is stored in the CADHOC[®] online library

CADHOC® SYSTEM DESIGNER – TOP-NOTCH SOFTWARE PROVIDED FOR YOUR SUPPORT

CADHOC® System Designer enables us to meet your needs for fast provision of product data on everything from individual components to complete hot runner systems, including negative volume.

Among other things, CADHOC® System Designer enables you to:

- Design nozzle sizes in an optimum way
- Select plastic types from a comprehensive list
- Make a direct configuration without any specifications of the processing parameters
- Make an application-based configuration with specifications of the processing parameters

3D CAD models on every hot runner system are available for download in a variety of different data formats. After entering your configuration parameters, you will receive an e-mail with a link to the product data of the configured hot runner system.





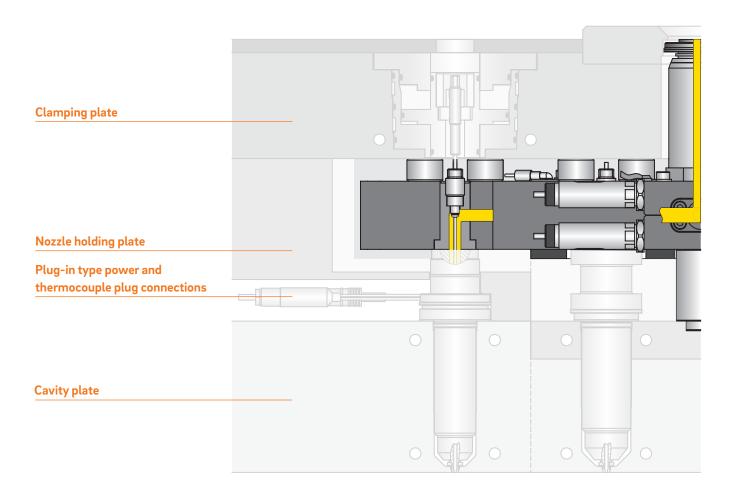
3.3 Valve gate manifolds

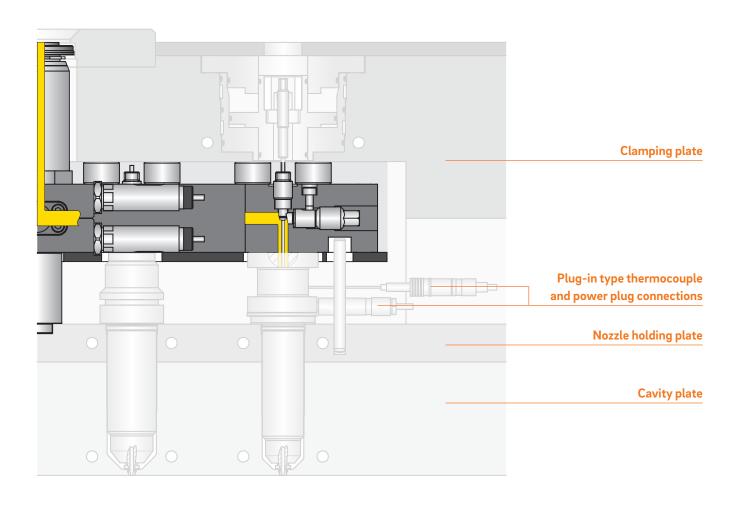
STRAIGHT MAN	STRAIGHT MANIFOLDS		
	NGCP Manifold length (VL) 160-360	30	
	NGCP Manifold length (VL) 410-510	40	
	NGDP Manifold length (VL) 160-360	50	
	NGDP Manifold length (VL) 410-510	60	
H-MANIFOLDS			
	NHCP/NHDP/NHEP	70	
CROSS MANIFO	DLDS		
	NKCP4/NKDP4 Manifold length (VL) 135-165	80	
	NKCP4/NKDP4 Manifold length (VL) 180	90	
	NKCP4/NKDP4 Manifold length (VL) 210	100	
33	NKCP4/NKDP4 Manifold length (VL) 240/270/300	110	
STAR MANIFOL	DS		
50.03	NSCP/NSDP/NSEP	120	
T-MANIFOLDS			
	NTCP/NTDP/NTEP	130	



Overview of overall design

for valve gate manifolds







Straight manifold type NGCP

Manifold length (VL) 160-360



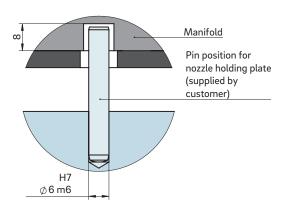
TECHNICAL DATA

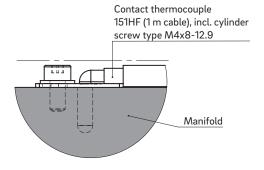
NGCP VL 160-360

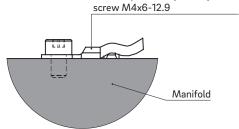
Manifold height	36 mm				
Operating voltage	230 V _{AC} *				
Manifold length (VL)	210 260 310 360				
Control circuits	1	1	1	1	1
Power (watts) per control	2 × 750		2 × 1000		

^{*}Volts alternating current



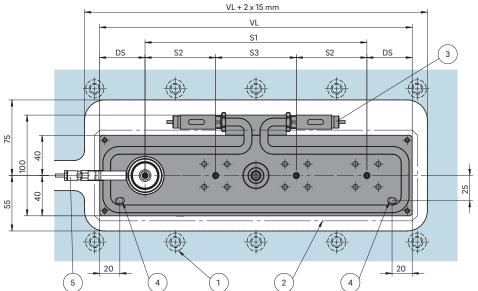




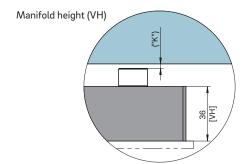




Nozzle tip view



- DS Edge distance: a. min. 35.0 with nozzle size ≤ 6 b. min. 45.0 with nozzle size 8
- S1 Largest pitch (max. pitch)
- S2 Pitch between the nozzles (min./max. pitch)
- S3 Pitch between the nozzles, taking connecting element and spacer into account (min./max. pitch)
- ① Screw connection close to manifold
- 2 High-temperature insulation plate
- 3 Heating connections
- 4 Possible pin position
- (5) Opening and plug location dependent upon nozzle type



Design examples/Balancing

Туре		Melt channel Ød in mm	Number of drops
NGCP1B	• <u>d</u>	≤ 8	1
NGCP2B	• d	≤ 8	2
NGCP4B	•d	≤ 8	4
NGCP8T	d	≤ 8	8

B = balanced T = partially balanced

Dimension "K" required for heat expansion is to be ensured by grinding the pressure pad (12 + 0.1 mm)! Determine the difference between the height of the manifold system and the height of the frame plate when installed! ΔT specifies the temperature differential between the processing temperature and the mould temperature!

VH	ΔT (°C)	100	150	200	250	300	350
36 mm	K (mm)	0.021	0.059	0.098	0.137	0.177	0.217



Straight manifold type NGCP

Manifold length (VL) 410-510



TECHNICAL DATA

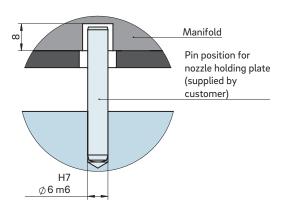
NGCP VL 410-510

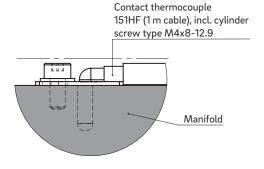
Manifold height (VH)	36 mm
Operating voltage	230 V _{AC} *

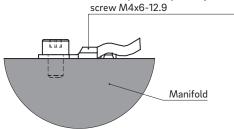
Manifold length (VL)	410	460	510
Control circuits	2	2	2
Power (watts) per control circuit	2 × 850	2 × 950	2 × 1000

^{*}Volts alternating current



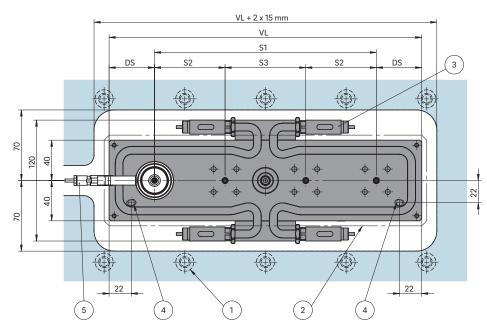




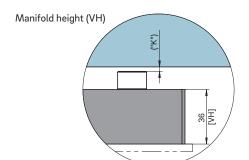




Nozzle tip view



- DS Edge distance: a. min. 35.0 with nozzle size ≤ 6 b. min. 45.0 with nozzle size 8
- S1 Largest pitch (max. pitch)
- S2 Pitch between the nozzles (min./max. pitch)
- S3 Pitch between the nozzles, taking connecting element and spacer into account (min./max. pitch)
- ① Screw connection close to manifold
- 2 High-temperature insulation plate
- 3 Heating connections
- 4 Possible pin position
- (5) Opening and plug location dependent upon nozzle type



Design examples/Balancing

Туре		Melt channel Ød in mm	Number of drops
NGCP1B	• <u>d</u>	≤ 8	1
NGCP2B	• d	≤ 8	2
NGCP4B	d	≤ 8	4
NGCP6T		≤ 8	6
NGCP8T	d	≤ 8	8

B = balanced T = partially balanced

Dimension "K" required for heat expansion is to be ensured by grinding the pressure pad (12 + 0.1 mm)! Determine the difference between the height of the manifold system and the height of the frame plate when installed! ΔT specifies the temperature differential between the processing temperature and the mould temperature!

VH	ΔT (°C)	100	150	200	250	300	350
36 mm	K (mm)	0.021	0.059	0.098	0.137	0.177	0.217



Straight manifold type NGDP

Manifold length (VL) 160-360



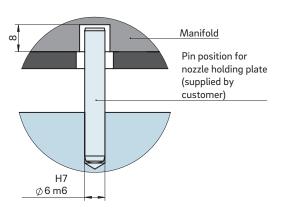
TECHNICAL DATA

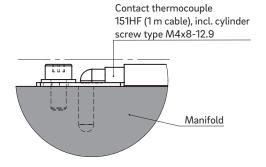
NGDP VL 160-360

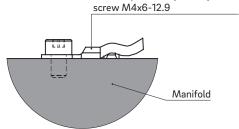
Manifold height	46 mm				
Operating voltage	230 V _{AC} *				
Manifold length (VL)	210 260 310 360				
Control circuits	1	1	1	1	1
Power (watts) per control circuit	2 × 750		2 × 1000		

^{*}Volts alternating current



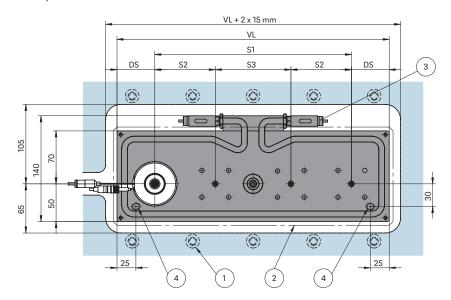






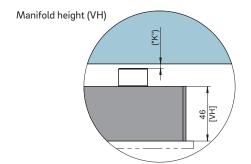


Nozzle tip view



DS Edge distance: a. min. 35.0 with nozzle size ≤ 6 b. min. 45.0 with nozzle size 8 or 10 c. min. 50.0 with nozzle size ≥ 12

- S1 Largest pitch (max. pitch)
- S2 Pitch between the nozzles (min./max. pitch)
- S3 Pitch between the nozzles, taking connecting element and spacer into account (min./max. pitch)
- ① Screw connection close to manifold
- 2 High-temperature insulation plate
- 3 Heating connections
- Possible pin position
- 5 Opening and plug location dependent upon nozzle type



Design examples/Balancing

_			
Туре		Melt channel Ød in mm	Number of drops
NGDP1B	• <u>d</u>	≥ 10 to 12	1
NGDP2B	• <u>d</u>	≥ 10 to 12	2
NGDP4B	d	≥ 10 to 12	4
NGDP6T	d • • • • •	≤ 8	6

B = balanced T = partially balanced

Dimension "K" required for heat expansion is to be ensured by grinding the pressure pad (12 + 0.1 mm)! Determine the difference between the height of the manifold system and the height of the frame plate when installed! ΔT specifies the temperature differential between the processing temperature and the mould temperature!

VH	ΔT (°C)	100	150	200	250	300	350
46 mm	K (mm)	0.033	0.078	0.124	0.170	0.218	0.264



Straight manifold type NGDP

Manifold length (VL) 410-510



TECHNICAL DATA

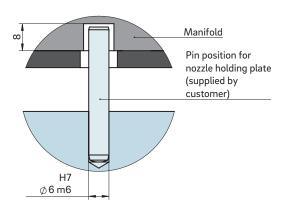
NGDP VL 410-510

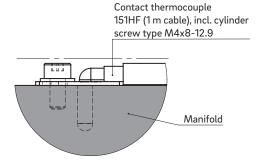
Manifold height (VH)	46 mm
Operating voltage	230 V _{AC} *

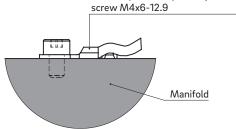
Manifold length (VL)	410	460	510
Control circuits	2	2	2
Power (watts) per control circuit	2 × 850	2 × 950	2 × 1000

^{*}Volts alternating current



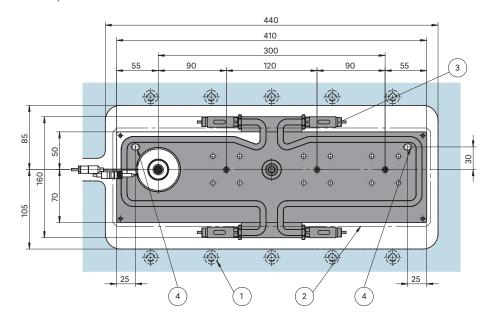






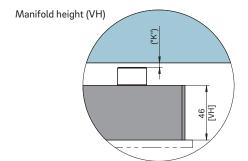


Nozzle tip view



DS Edge distance: a. min. 35.0 with nozzle size ≤ 6 b. min. 45.0 with nozzle size 8 or 10 c. min. 50.0 with nozzle size ≥ 12

- S1 Largest pitch (max. pitch)
- S2 Pitch between the nozzles (min./max. pitch)
- S3 Pitch between the nozzles, taking connecting element and spacer into account (min./max. pitch)
- 1 Screw connection close to manifold
- 2 High-temperature insulation plate
- (3) Heating connections
- 4 Possible pin position
- 5 Opening and plug location dependent upon nozzle type



Design examples/Balancing

Туре		Melt channel Ød in mm	Number of drops
NGDP1B	• <u>d</u>	≥ 12	1
NGDP2B	• d	≥ 12	2
NGDP4B	d	≥ 12	4
NGDP6T	d • • • •	≤ 8	6
NGDP8T	• d	≥ 12	8

B = balanced T = partially balanced

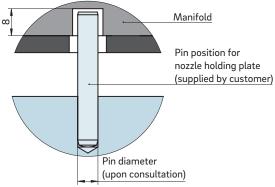
Dimension "K" required for heat expansion is to be ensured by grinding the pressure pad (12 + 0.1 mm)! Determine the difference between the height of the manifold system and the height of the frame plate when installed! ΔT specifies the temperature differential between the processing temperature and the mould temperature!

VH	ΔT (°C)	100	150	200	250	300	350
46 mm	K (mm)	0.033	0.078	0.124	0.170	0.218	0.264



H-manifold type NHCP/NHDP/NHEP



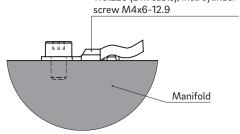


151HF (1 m cable), incl. cylinder screw type M4x8-12.9

Manifold

Contact thermocouple

PE protective conductor terminal 110.229 (2 m cable), incl. cylinder screw M4x6-12.9



TECHNICAL DATA

NHCP/NHDP/NHEP

Manifold height (VH) NHCP: 36 mm

NHDP: 46 mm

NHEP: 56 mm

Operating voltage 230 V_{AC}*

Manifold length (VL) $H + 2 \times DS$

Manifold width (VB) $B + 2 \times DS$

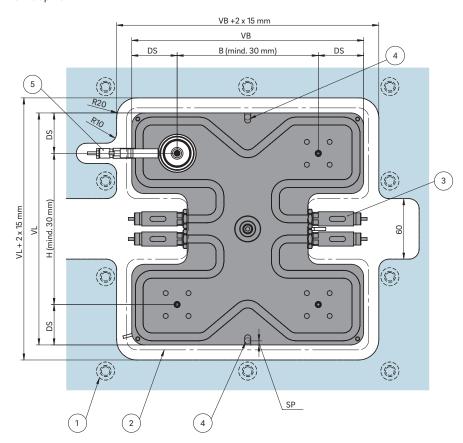
The heating output of each control circuit is calculated individually.

*Volts alternating current



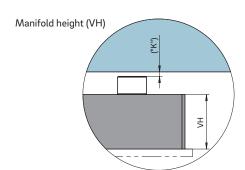


Nozzle tip view



DS Edge distance: a. min. 35.0 with nozzle size ≤ 6 b. min. 45.0 with nozzle size 8 or 10 c. min. 50.0 with nozzle size ≥ 12

- H Pitch between the nozzles
- B Pitch between the nozzles
- 1 Screw connection close to manifold
- ② High-temperature insulation plate ③ Heating connections
- 4 Possible pin position "SP" = d/2 + 1 mm
- (5) Opening and plug location dependent upon nozzle type



Dimension "K" required for heat expansion is to be ensured by grinding the pressure pad (12 + 0.1 mm)! Determine the difference between the height of the manifold system and the height of the frame plate when installed! ΔT specifies the temperature differential between the processing temperature and the mould temperature!

VH	ΔT (°C)	100	150	200	250	300	350
36 mm	K (mm)	0.021	0.059	0.098	0.137	0.177	0.217
46 mm	K (mm)	0.033	0.078	0.124	0.170	0.218	0.264
56 mm	K (mm)	0.046	0.097	0.150	0.203	0.258	0.311

Design examples/Balancing

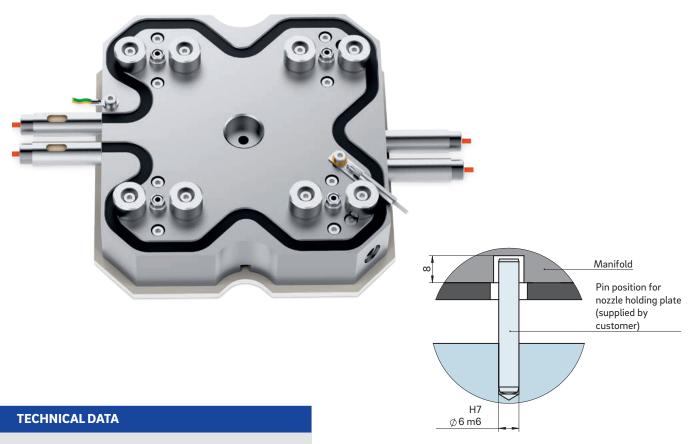
Туре		, ,	NHDP = 46 (VH) Melt channel Ød in mm	, ,	
NH_P4B	d	≤ 8	≥ 10 to 12	≥ 16	4
NH_P6T	d	≤ 8	≥ 10 to 12	≥ 16	6
NH_P6B	d		≤ 8	≤ 10	6
NH_P8B	d	≤ 8	≥ 10 to 12	≥ 16	8
NH_P12B	d		≤ 8	≤ 10	12
NH_P16B	d ()	≤ 8	≥ 10 to 12	≥ 16	16

B = balanced T = partially balanced



Cross manifold type NKCP4/NKDP4

Manifold length (VL) 135-165



NKCP4/NKDP4 135/165

Manifold height (VH) NKCP: 36 mm

NKDP: 46 mm

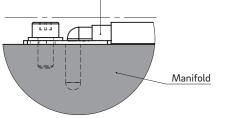
Operating voltage $230 \, V_{AC}^*$

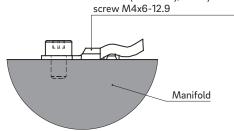
Manifold length (VL)	135	165
Pin position (SP)	63.5	68.0
Control circuits	1	1
Power (watts) per control circuit	2 × 850	2 × 1000

^{*}Volts alternating current



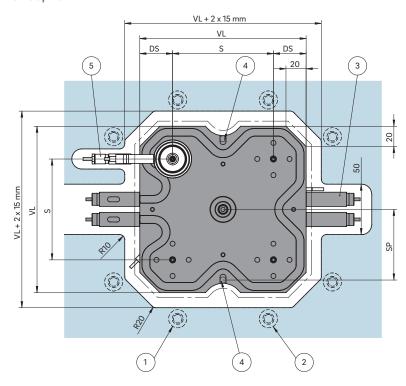








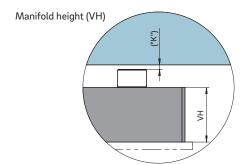
Nozzle tip view



DS Edge distance: a. min. 35.0 with nozzle size ≤ 6 b. min. 45.0 with nozzle size 8 or 10c. min. 50.0 with nozzle size ≥ 12

S Pitch between the nozzles

- \bigcirc Screw connection close to manifold
- 2) High-temperature insulation plate
 3) Heating connections
- 4 Possible pin position
- 5 Opening and plug location dependent upon nozzle type



Design examples/Balancing

Туре		NKCP = 36 (VH) Melt channel Ød in mm	NKDP = 46 (VH) Melt channel Ød in mm	Number of drops
NIZ DAD	d	≤ 8	≥ 10 to 12	4
NK_P4B		DS min. 35	DS min. 50	4

B = balanced

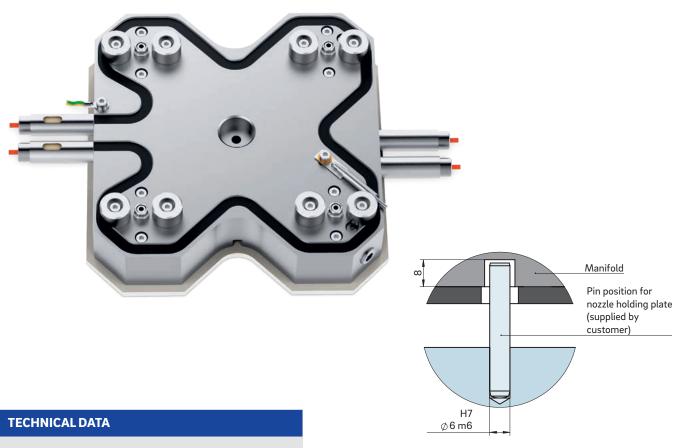
Dimension "K" required for heat expansion is to be ensured by grinding the pressure pad (12 + 0.1 mm)! Determine the difference between the height of the manifold system and the height of the frame plate when installed! ΔT specifies the temperature differential between the processing temperature and the mould temperature!

VH	ΔT (°C)	100	150	200	250	300	350
36 mm	K (mm)	0.021	0.059	0.098	0.137	0.177	0.217
46 mm	K (mm)	0.033	0.078	0.124	0.170	0.218	0.264



Cross manifold type NKCP4/NKDP4

Manifold length (VL) 180



NKCP4/NKDP4 180

Manifold height (VH) NKCP: 36 mm NKDP: 46 mm

Operating voltage 230 V_{AC}*

Manifold length (VL) 180

Pin position (SP) 59.0

Control circuits 1

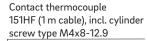
Power (watts)

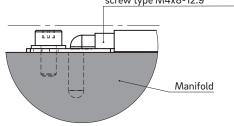
per control circuit

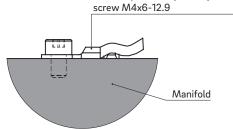


2 ×

1000



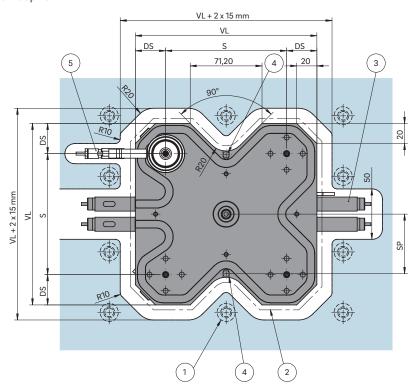




^{*}Volts alternating current



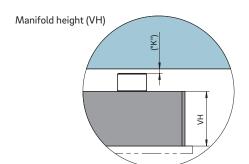
Nozzle tip view



DS Edge distance: a. min. 35.0 with nozzle size ≤ 6 b. min. 45.0 with nozzle size 8 or 10 c. min. 50.0 with nozzle size ≥ 12

S Pitch between the nozzles

- ① Screw connection close to manifold
- (2) High-temperature insulation plate
- (3) Heating connections
- 4 Possible pin position
- (5) Opening and plug location dependent upon nozzle type



Design examples/Balancing

Туре		NKCP = 36 (VH) Melt channel Ød in mm	NKDP = 46 (VH) Melt channel Ød in mm	Number of drops
NIZ DAD	d	≤ 8	≥ 10 to 12	4
NK_P4B		DS min. 35	DS min. 50	4

B = balanced

Dimension "K" required for heat expansion is to be ensured by grinding the pressure pad (12 + 0.1 mm)! Determine the difference between the height of the manifold system and the height of the frame plate when installed! ΔT specifies the temperature differential between the processing temperature and the mould temperature!

VH	ΔT (°C)	100	150	200	250	300	350
36 mm	K (mm)	0.021	0.059	0.098	0.137	0.177	0.217
46 mm	K (mm)	0.033	0.078	0.124	0.170	0.218	0.264



Cross manifold type NKCP4/NKDP4

Manifold length (VL) 210



TECHNICAL DATA

NKCP4/NKDP4 210

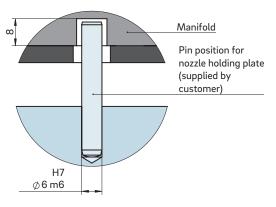
Manifold height (VH)			36 mm 46 mm
Operating voltage	230	V _{AC}	*
Manifold length (VL)			210
Pin position (SP)			60.8
Control circuits			1
Power (watts)			2 ×

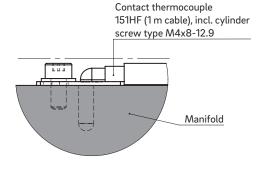
^{*}Volts alternating current

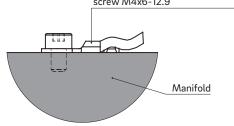
per control circuit



1000

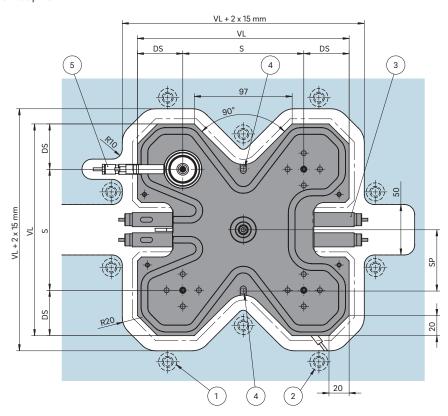








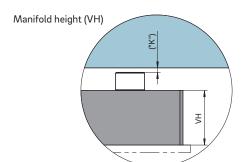
Nozzle tip view



DS Edge distance: a. min. 35.0 with nozzle size ≤ 6 b. min. 45.0 with nozzle size 8 or 10 c. min. 50.0 with nozzle size ≥ 12

Pitch between the nozzles

- ① Screw connection close to manifold
- 2 High-temperature insulation plate
- (3) Heating connections
- 4 Possible pin position5 Opening and plug location dependent upon nozzle type



Design examples/Balancing

Туре		NKCP = 36 (VH) Melt channel Ød in mm	NKDP = 46 (VH) Melt channel Ød in mm	Number of drops
NK_P4B	d	≤ 8	≥ 10 to 12	4
		DS min. 35	DS min. 50	4

B = balanced

Dimension "K" required for heat expansion is to be ensured by grinding the pressure pad (12 + 0.1 mm)! Determine the difference between the height of the manifold system and the height of the frame plate when installed! ΔT specifies the temperature differential between the processing temperature and the mould temperature!

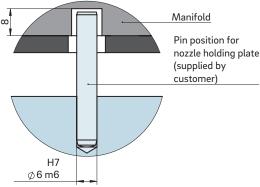
VH	ΔT (°C)	100	150	200	250	300	350
36 mm	K (mm)	0.021	0.059	0.098	0.137	0.177	0.217
46 mm	K (mm)	0.033	0.078	0.124	0.170	0.218	0.264



Cross manifold type NKCP4/NKDP4

Manifold length (VL) 240/270/300





TECHNICAL DATA

NKCP4/NKDP4 240/270/300

Manifold height (VH) NKCP: 36 mm

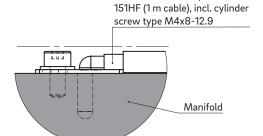
NKDP: 46 mm

Operating voltage 230 V_{AC}*

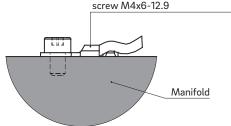
240	270	300
81.0	87.5	101.0
127.0	156.6	187.0
2	2	2
2 × 1000	2 × 1350	2 × 1500
	81.0 127.0 2 2 ×	81.0 87.5 127.0 156.6 2 2 2× 2×

^{*}Volts alternating current



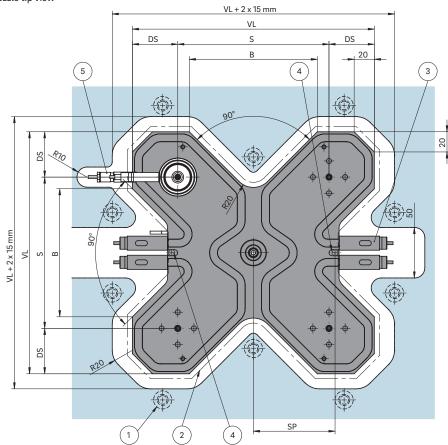


Contact thermocouple









DS Edge distance: a. min. 35.0 with nozzle size ≤ 6 b. min. 45.0 with nozzle size 8 or 10c. min. 50.0 with nozzle size ≥ 12

Pitch between the nozzles

- $\begin{tabular}{l} \begin{tabular}{l} \begin{tab$
- 2 High-temperature insulation plate
 3 Heating connections
 4 Possible pin position
- 5 Opening and plug location dependent upon nozzle type

Manifold height (VH) ("K") ¥

Design examples/Balancing

Туре		NKCP = 36 (VH) Melt channel Ød in mm	NKDP = 46 (VH) Melt channel Ød in mm	Number of drops
NIZ DAD	d	≤ 8	≥ 10 to 12	4
NK_P4B	d O	DS min. 35	DS min. 50	4

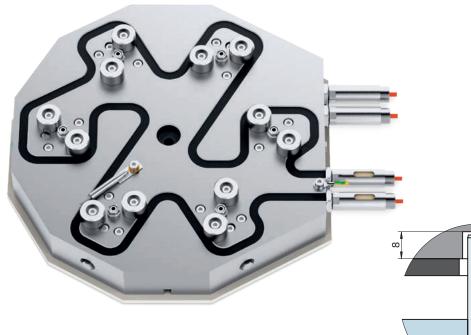
B = balanced

Dimension "K" required for heat expansion is to be ensured by grinding the pressure pad (12 + 0.1 mm)! Determine the difference between the height of the manifold system and the height of the frame plate when installed! ΔT specifies the temperature differential between the processing temperature and the mould temperature!

VH	ΔT (°C)	100	150	200	250	300	350
36 mm	K (mm)	0.021	0.059	0.098	0.137	0.177	0.217
46 mm	K (mm)	0.033	0.078	0.124	0.170	0.218	0.264



Star manifold type NSCP/NSDP/NSEP



TECHNICAL DATA

NSCP/NSDP/NSEP

Manifold height (VH) NSCP: 36 mm

NSDP: 46 mm NSEP: 56 mm

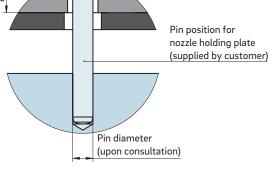
Operating voltage 230 V_{AC}*

Manifold length (VL) $ØTK + 2 \times DS$

The heating output of each control circuit is calculated individually.

*Volts alternating current



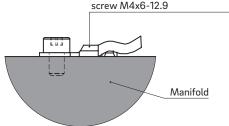


Contact thermocouple

Manifold

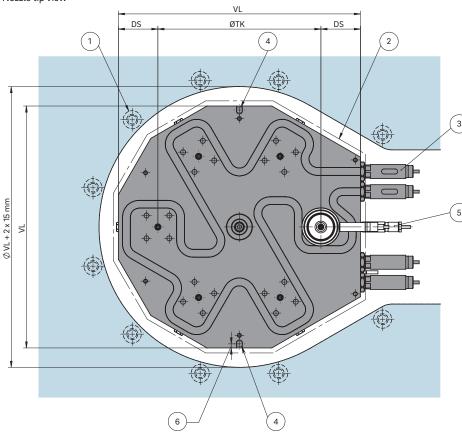
151HF (1 m cable), incl. cylinder screw type M4x8-12.9

Manifold









DS Edge distance: a. min. 35.0 with nozzle size ≤ 6 b. min. 45.0 with nozzle size 8 or 10 c. min. 50.0 with nozzle size ≥ 12

ØTK Pitch circle diameter

- ① Screw connection close to manifold ② High-temperature insulation plate
- 3 Heating connections
- 4 Possible pin position
- 5 Opening and plug location dependent upon nozzle type

 6 Pin position "SP" = d/2 + 1 mm

Manifold height (VH) ("K") ¥

Dimension "K" required for heat expansion is to be ensured by grinding the pressure pad (12 + 0.1 mm)! Determine the difference between the height of the manifold system and the height of the frame plate when installed! ΔT specifies the temperature differential between the processing temperature and the mould temperature!

VH	ΔT (°C)	100	150	200	250	300	350
36 mm	K (mm)	0.021	0.059	0.098	0.137	0.177	0.217
46 mm	K (mm)	0.033	0.078	0.124	0.170	0.218	0.264
56 mm	K (mm)	0.046	0.097	0.150	0.203	0.258	0.311

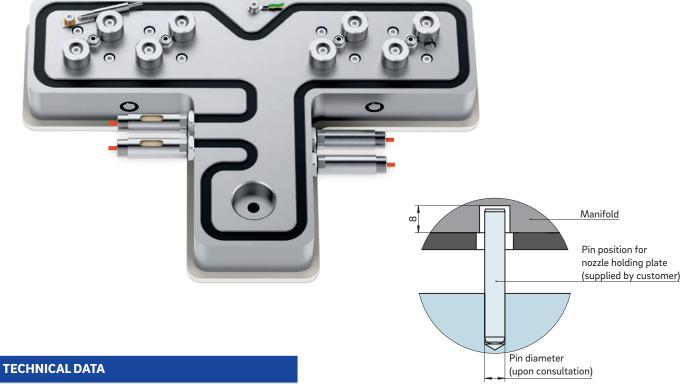
Design examples/Balancing

Туре		NSCP = 36 (VH) Melt channel Ød in mm	NSDP = 46 (VH) Melt channel Ød in mm	NSEP = 56 (VH) Melt channel Ød in mm	Num- ber of drops
NS_P3B	d	≤ 8	≥ 10 to 12	≥ 16	3
NS_P6B	d		≤ 8	≤ 10	6
NS_P8B	d		≤ 8	≤ 10	8

B = balanced



T-manifold type NTCP/NTDP/NTEP



NTCP/NTDP/NTEP

Manifold height (VH) NTCP: 36 mm

NTDP: 46 mm NTEP: 56 mm

Operating voltage $230 \, V_{AC}^{*}$

Manifold length (VL) $S1 + 2 \times DS$

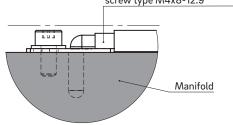
Manifold width (VB) $T + 2 \times 40 \text{ mm}$

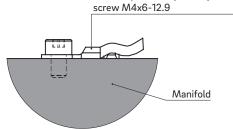
The heating output of each control circuit is calculated individually.

*Volts alternating current



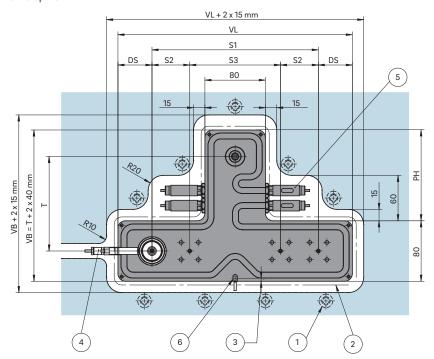






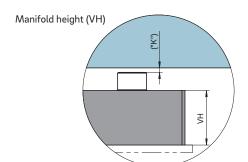


Nozzle tip view



DS Edge distance: a. min. 35.0 with nozzle size ≤ 6 b. min. 45.0 with nozzle size 8 or 10 c. min. 50.0 with nozzle size ≥ 12

- T Distance from the connecting nozzle to the nozzle row
- ① Screw connection close to manifold
- 2 High-temperature insulation plate
- ③Pin position "SP" = d/2 + 1 mm
- 4 Opening and plug location dependent upon nozzle type
- (5) Position of the heating connections with PH ≥ 100
- ⑥ Position of the heating connections with PH ≤ 100; different heating connection positions require consultation with the design office



Dimension "K" required for heat expansion is to be ensured by grinding the pressure pad (12 + 0.1 mm)! Determine the difference between the height of the manifold system and the height of the frame plate when installed! ΔT specifies the temperature differential between the processing temperature and the mould temperature!

VH	ΔT (°C)	100	150	200	250	300	350
36 mm	K (mm)	0.021	0.059	0.098	0.137	0.177	0.217
46 mm	K (mm)	0.033	0.078	0.124	0.170	0.218	0.264
56 mm	K (mm)	0.046	0.097	0.150	0.203	0.258	0.311

Design examples/Balancing

	· · · · · · · · · · · · · · · · · · ·				
Туре		, ,	NTDP = 46 (VH) Melt channel Ød in mm	, ,	Num- ber of drops
NT_P2B	d O	≤ 8	≥ 10 to 12	≥ 16	2
NT_P4-	d	≤ 8	≥ 10 to 12	≥ 16	4
NT_P4B	d	≤ 8	≥ 10 to 12	≥ 16	4
NT_P6T	d	≤ 8	≥ 10 to 12	≥ 16	6
NT_P8T	d	≤ 8	≥ 10 to 12	≥ 16	8

B = balanced T = partially balanced - = not balanced